## **Amendments to the Claims**

This listing of Claims will replace all prior versions, and listings of claims in the application:

## **Listing of Claims:**

Claims 1 - 16 (cancelled).

Claim 17 (currently amended): A structure of a LED device, the structure comprising:

a LED substrate having an uppermost a GaP layer thereon; and

a <u>liquid phase epitaxy grown</u> transparent layer having Zn dopants therein on said <del>uppermost</del> <u>GaP</u> layer of said LED substrate, wherein said transparent layer is composed of a semiconductor compound different to that of said <del>uppermost</del> GaP layer.

Claim 18 (canceled).

Claim 19 (currently amended): The structure according to claim 17, wherein said transparent layer is formed by liquid phase epitaxy process utilizing utilizes a supersaturated solution comprising metallic antimony (Sb) and indium (In) as a solvent.

Claim 20 (currently amended): The structure according to claim 18, wherein said Zn dopant is in an amount of 1/1000 to 1/10 by weight of a solvent of a supersaturated solution in the <u>liquid phase epitaxy LPE-process</u>.

Claim 21 (currently amended): The structure according to claim 19, wherein said Zn dopant is in an amount of 1/1000 to 1/10 by weight of Sb of the supersaturated solution in the <u>liquid phase epitaxy LPE process</u>.

Claim 22 (currently amended): A structure of a LED device, the structure comprising:

a LED substrate having an uppermost a GaP layer thereon; and an non-GaP transparent layer having Zn dopants therein on said uppermost GaP layer formed by a LPE liquid phase epitaxy process using a supersaturated solution.

Claim 23 (currently amended): The structure according to claim 22, wherein said non-GaP transparent layer is formed by LPE liquid phase epitaxy process utilizing a supersaturated solution comprising metallic antimony (Sb) and indium (In) as a solvent.

and Advisory Action dated 23 December 2005

Claim 24 (currently amended): The structure according to claim 22,

wherein said Zn dopant is in an amount of 1/1000 to 1/10 by weight of

a solvent of a supersaturated solution in the LPE liquid phase epitaxy

process.

Claim 25 (currently amended): The structure according to claim 22,

wherein said Zn dopant is in an amount of 1/1000 to 1/10 by weight of

Sb of the supersaturated solution in the LPE liquid phase epitaxy

process.

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